

Smarter technology for all

LENOVO DESKTOPS FOR A SMART FACTORY EXPERIENCE

Learn more at Lenovo.com



Built for Business

Intel vPro[®] platform

DIGITIZING THE MANUFACTURING INDUSTRY

The manufacturing industry has long marched to the digitization drumbeat. Advancements in technology have acted as a catalyst, transforming the shop floor infrastructure to connect R&D to supply chain management. With data collection and analytics, real-time updates are now possible at every stage of production.

Industry 4.0 has converged the physical and digital worlds with technologies such as IoT, AI, Cloud, Big Data, Analytics, and 3D-printing. These are among the emerging technologies that enabled the rise of smart factories. By using Cloud-based automatic data collection and analysis to ensure a transparent supply chain and facilitate informed decision making, organizations have reaped the benefits of increased ROI. Factories are becoming digitally connected and increasingly automated, and one thing is clear - the Fourth Industrial Revolution is all about reinventing the manufacturing industry.

To benefit from the revolution, organizations need to recognize their challenges and strategize accordingly. Some of the biggest challenges manufacturing businesses face are:

- Harnessing the power of Big Data and Analytics
- Data security
- Implementing IoT innovation
- Improving workforce productivity

To overcome these challenges, organizations need reliable and innovative technology, powered by Intel[®] vPro[®] Essentials and Enterprise platform and Windows 11 Pro, to deliver higher workforce productivity, better decision making through effective analytics, and faster product development. Lenovo's business-boosting technologies can empower their future-ready workforce to stay productive, connected, and secure - wherever work happens.



Built for Business Intel vPro[®] platform



MILITARY-STD-810H DURABILITY & RELIABILITY

ThinkCentre M product portfolio is Military Standard (MIL-STD) Certified with 12 methods and 20 procedures.





ThinkCentre **M** Tower

ThinkCentre ThinkCentre M SFF M Tiny





ThinkEdge SE50



ThinkCentre All-In-One



VIBRATION Tested while running and turned off



HUMIDITY 95% relative humidity, at 30°C-60°C



600

HIGH TEMPERATURE Storage: 63°C for 24 hrs Operation: 43°C for 2 hrs

FUNGUS

28 days with common fungus sources



SOLAR RADIATION Three 24-hr. cycles of

simulated UV radiation

TEMPERATURE SHOCK

Tested in temperature shock cycles going from -25°C to 60°C for 6 hrs













Intel vPro[®] platform

ThinkEdge SE30

LOW TEMPERATURE

Storage: -25°C for 24 hrs Operation: -21°C for 2 hrs

SAND & DUST

140 mesh silica dust for 14 hr. cycles

CONTAMINATION BY FLUIDS

Chemicals on exposed surface 5-10 min

ALTITUDE

Tested for operations at 15,000 feet

SHOCK

Transit dropped tested in every corner 26 times

SALT FOG

24 hrs spray + 24 hrs dry, 2 cycles



Lenovo

THINKCENTRE ENVIRONMENTAL, SOCIAL & GOVERNANCE (ESG)



CIRCULAR ECONOMY

Our product takeback programs (PTBs) make it very easy for customers around the world to recycle their old devices, batteries, and packaging. Keeping end-of-life products **out of landfills**.

SUSTAINABLE PACKAGING

Now uses **30%** recycled white EPE foam. By 2025, **90%** will be made from recycled materials.

5 KEY FOCUS AREAS

ENERGY CONSERVATION/ CARBON MITIGATION

As of March 2021, ThinkCentre energy achieved a 33.06% efficiency saving of 100 million kWh could **Round the Earth 13400 times** with an electric vehicle. By 2050, we will improve to 50%.

intel.



i9

Intel vPro[®] with 12th Gen Intel[®] Core[™] i9 processor

Lenovo



SOCIAL IMPACT

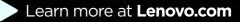
Lenovo ThinkCentre products, powered by up to Intel vPro® with 12th Gen Intel® Core™ i9 processors, are made with

conflict-free minerals



RECYCLED MATERIALS

100% of the ThinkCentre models released after 2019 uses recycled plastic content.



4





ThinkEdge SE70

ThinkEdge se

With a ruggedized design built to tackle complex environments and automate Internet of Things (IoT) applications, ThinkEdge SE devices are powered by the latest **Intel vPro® with 12th Gen Intel® Core™ i5 processor** to streamline manufacturing operations with real-time data processing from operations to IT. This makes it ready-built for challenging edge applications, complete with Wi-Fi, Bluetooth®, and 4G LTE or 5G WWAN wireless connections to efficiently transport your IoT data to the cloud or your data center.

An optional IOBOX with configurable serial interfaces, two POE ports, and DI/DO connectors provides even greater connectivity for manufacturing scenarios.

SUITABLE FOR

IoT management, as well as planning and design for sensors and devices integration.

KEY FEATURES

MIL-STD-810H, Operating temperature range from -20° to 60° C, Self Healing BIOS, BIOS-based Smart USB Protection



vPRO
Intel vPro[®] with 12th Gen
Intel[®] Core[™] i5 processor

ThinkEdge SE30

ThinkEdge SE30

Processor

Up to 12th Gen Intel® Core[™] i5 vPro® Processor

Storage 256GB SSD+ 512GB SSD

Graphic Integrated GPU

Memory 8GB

Security Kensington™ Cable Lock, VESA mount lock, Intel® vPro®



Green Certifications

ErP Lot 6, Low Halogen, RoHS compliant, REACH, PCF, TED (ECO-declaration), WEEE

Other Certifications

EMC, EMC CE / FCC Class B, BSMI, CCC, Safety: UL(ETL), BSMI, CB, CCC



ThinkCentre M90

The newest generation of ThinkCentre M90 series offer best-in-class performance, expandability, and security delivered in even smaller, modern desktop designs that boost productivity as well as business.

With up to Intel vPro[®] with 12th Gen Intel[®] Core[™] i9 processor, ThinkCentre M90 offers robust, unrivaled performance, lightning-fast speed, productivity enhancing upgrades like Modern Standby, and the ability to connect to up to three displays. Maximum expandability lets you bridge between legacy peripherals and future storage needs. Security and manageability are covered inside and out with ThinkShield solutions and the Intel[®] vPro[®] platform – so power users in the manufacturing industry such as technical engineers and concept designers can safeguard their data confidently.

SUITABLE FOR

Head of R&D and Product Manager who require high performance computing on product research for innovation, development, testing, and analysis

KEY FEATURES

Intel vPro® Enterprise, dTPM 2.0 chip, Self Healing BIOS , BIOS-based Smart USB Protection, Intelligent Cooling Engine (ICE 5.0), Supports up to 4 monitors



vPRO[°] i9

Intel vPro[®] with 12th Gen Intel[®] Core[™] i9 processor



ThinkCentre M90t Tower

Processor Up to 12th Gen Intel® Core™ i9 vPro® Processors

Storage 2 x 512GB SSD + 1TB HDD

Graphics Discrete GPU

Memory 4 x 16GB

RECOMMENDED ADD-ONS





ThinkVision P27q-30

Kensington Security lock





ThinkCentre M90t Tower

Security

SentinelOne, Intel® vPro® Enterprise, , Kensington™ Cable

Certifications

MIL-STD-810H, Energy Star[®], EPEAT[™], RoHS, TÜV Rheinland[®], Low Noise, TCO 8.0



SentinelOne

Learn more at Lenovo.com

ThinkCentre M80

Lenovo ThinkCentre M80 is built to accelerate your innovation, whichever industry you are in. With up to Intel vPro[®] with 12th Gen Intel[®] Core[™] i9 processor, the all-new ThinkCentre M80 offers powerful performance to meet today's needs plus easy ways to expand and upgrade now or over the long term. Users can connect to up to three displays for maximum multitasking.

Professionals in the manufacturing industry such as warehouse and logistics managers can secure their data with built-in security features such as ThinkShield solutions and the Intel[®] vPro[®] Enterprise platform.

SUITABLE FOR

Testing in Production (TiP), that requires manufacturing QC and sensitive data security compliance.

KEY FEATURES

Intel vPro® Enterprise, dTPM 2.0 chip, Self Healing BIOS , BIOS-based Smart USB Protection, Intelligent Cooling Engine (ICE 5.0), Supports up to 4 monitors

ThinkCentre M80s SFF

ThinkCentre M80s SFF

Processor	Se
Up to 12 th Gen Intel® Core™ i9	Sei
vPro® Processors	Pla
Storage	Ce
512GB SSD + 1TB HDD	Mil
Graphics	EP
Discrete GPU	Lo

Dis

Memory 2 x 32GB

RECOMMENDED ADD-ONS





ThinkVision P27i-30

Custom Image Services

intel vPRO **i9**

Intel vPro[®] with 12th Gen Intel[®] Core[™] i9 processor





curity

ntinelOne, Intel[®] vPro[®] atform, Kensington™ Cable Lock

rtifications

_-STD-810H, Energy Star[®], PEAT™, RoHS, TÜV Rheinland®, w Noise, TCO 8.0





ThinkShield Protection

Learn more at Lenovo.com

ThinkCentre M70

The newest ThinkCentre M70 is powered by **Intel® Core™ i3 processors** that offer enterprise-level performance, speed, and potential in a desktop so small it can fit almost anywhere. With easy handling of heavy files and efficient multitasking capability, production and operations managers can amplify productivity.

It's also configurable and expandable, with low energy consumption and a host of other features such as offers remote power-up and support for up to four independent monitors. ThinkCentre M70 with the M70 vPro Essentials platform combines everything users want with the security and manageability capabilities businesses need.

SUITABLE FOR

Manufacturing facility managers who are in-charge of manufacturing plant compliance, productivity requirements, and business needs.

KEY FEATURES

intel.

CORE

i3

Modern Standby, Supports up to 4 independent monitors, Smart Power On

ThinkCentre M70q Tiny

Processor

Up to 12th

Processor

Storage

1TB HDD

Graphic

Memory

8GB

Integrated

Gen Intel® Core™ i3 s	Securit Mount Lock
	Certifie MIL-ST
GPU	8.0, EP LOT3, ⁻ TCO 9.
	Verifica

RECOMMENDED ADD-ONS





ThinkVision E24-28

Tiny Anti-Dust Mount

Powered by Intel® Core™ i3 processor





ThinkCentre M70q Tiny

ty Kit, Kensington™ Cable

cations

MIL-STD-810H, Energy Star[®] v 8.0, EPEAT[™] Gold, RoHS, ERP LOT3, TÜV Ultra Low Noise, TCO 9.0, Anti-Dust Performance Verification -UL, Verified Mark (Option)





Asset Recovery Services

Learn more at Lenovo.com

HIGHLIGHT TECH

Manufacturing professionals don't just require cutting-edge devices with fast processors. They also need the latest technologies packed with smarter, intuitive features to elevate their work experience, secure their data, and at the same time leaving the smallest carbon footprint possible.

LENOVO'S PORTFOLIO OF DESKTOPS **MEETS THE DEMANDS OF A MODERN WORKFORCE WITH FEATURES SUCH AS:**

 Remote Management and Access
Smart USB Protection (vPro[™] Enterprise)

With high-performance Intel vPro[®] Essentials, your IT team can remotely access your fleet of desktops, saving in both time and management costs.

• Range of form factors

Match your need with a Tower, Small Form Factor or Tiny, or choose a All-inOne and Tiny-in-One modular desktop.

(•) WMI/SCCM

Enhance user experience by using these tools to consolidate the management of devices and applications in a network.

Prevents data from being transferred from USB ports while still allowing connection to peripheral devices such as mouse & keyboard.

• Keyboard Power On

No need to be close to your desktop anymore to activate it. Use the "Keyboard Power On" shortcut on your keyboard to turn on your device.



Intel vPro[®] Essentials



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Built for Business

Intel vPro[®] platform

www.lenovo.com

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